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Adam Paul Karcz^{1,*}, Anne Juul Damø¹, Jytte Boll Illerup¹, Sara Rocks², Kim Dam-Johansen¹,
and David Chaiko²

¹ Department of Chemical and Biochemical Engineering, Danmarks Tekniske Universitet, Søtofts Plads, Building 229, 2800 Kongens Lyngby, Denmark

² FLSmidth USA Inc., 7158 S. FLSmidth Drive, Midvale, UT 84047 USA

Title:

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Author affiliations and addresses:

Adam Paul Karcz Danmarks Tekniske Universitet Dept. of Chemical and Biochemical Engineering Søtofts Plads 229 2800 Kongens Lyngby, Denmark adkr@kt.dtu.dk	Anne Juul Damø Danmarks Tekniske Universitet Dept. of Chemical and Biochemical Engineering Søtofts Plads 229 2800 Kongens Lyngby, Denmark ajp@kt.dtu.dk
Jytte Boll Illerup Danmarks Tekniske Universitet Dept. of Chemical and Biochemical Engineering Søtofts Plads 229 2800 Kongens Lyngby, Denmark jbi@kt.dtu.dk	Sara Rocks FLSmidth USA Inc. 7158 S. FLSmidth Drive Midvale, Utah 84047 USA Sally.Rocks@flsmidth.com
Kim Dam-Johansen Danmarks Tekniske Universitet Dept. of Chemical and Biochemical Engineering Søtofts Plads 229 2800 Kongens Lyngby, Denmark kdj@kt.dtu.dk	David Chaiko FLSmidth USA Inc. 7158 S. FLSmidth Drive Midvale, Utah 84047 USA David.Chaiko@flsmidth.com

Corresponding author will be Adam Paul Karcz, and he can be reached at +45 45 24 28 30.

* Address correspondence to E-mail: adkr@kt.dtu.dk

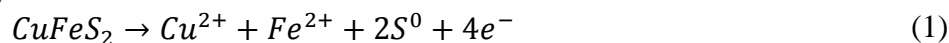
5 **ABSTRACT**

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8 Because of its unique semiconductor properties, the world's most abundant copper mineral, chalcopyrite
9 (CuFeS₂), is refractory with respect to atmospheric leaching using traditional acidic ferric sulfate
10 lixivants. FLSmidth[®] has developed a novel approach manipulating lattice properties of semi-
11 conducting minerals with the benefit of increasing chemical reactivity and dissolution kinetics. In the
12 FLSmidth[®] Rapid Oxidative Leach (ROL) process, leach kinetics are still further enhanced by
13 combining chemical and mechanical processes with the assistance of a Stirred Media Reactor. Due to
14 the reduction in surface passivation problems associated with atmospheric leaching, this process is
15 typically able to achieve copper recoveries exceeding 95% in 6 h. An important factor contributing
16 to this extraordinary process performance is a mineral preconditioning step (the focus of this study),
17 which uses between 0.1 and 5 mol percent of copper (II) to dope the lattice and thereby "activate"
18 chalcopyrite. Since lattice restructuring can have such a dramatic influence on semiconductor
19 reactivity, the associated physico-chemical phenomena are worth studying. In this regard, we
20 investigate the relationship between chemical activation and deformation of the chalcopyrite crystal
21 lattice through the use of electron microscopy. Although the activation process took only an hour
22 and the extent of conversion was on the order of a few mol%, the lattice was found to be strained
23 throughout the particle. This paper draws some insights into the impact of applying chemical
24 activation as a pretreatment for mechanochemical processes.
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32 **Introduction**

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35 Due to the near-term transitioning from copper oxide heap leaching to copper sulfide processing at a
36 large number of mine sites, there is much interest in finding a cost-effective leach process which
37 is compatible with current hydrometallurgical process infrastructures [1]. However, successful
38 atmospheric leaching of the world's most abundant copper mineral, chalcopyrite (CuFeS₂), has proven
39 to be difficult. The semiconductor properties of this mineral contribute to its refractory nature with
40 respect to traditional acidic ferric sulfate leaching aids [2, 3]. This behavior is believed to be related to
41 the re-supply of holes to the reaction surface as a rate-limiting step [4]. Additional contributory factors
42 to its refractory nature include: (1) the formation of surface-bound polysulfides, (2) an elemental
43 sulfur product layer, and (3) a variety of electrochemically passivating intermediate species, such as
44 Cu_{1-x}Fe_{1-y}S_{2-z} [5–10].
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50 The atmospheric oxidation of CuFeS₂ involves the Fe(II)/Fe(III) redox couple as the primary oxidant,
51 as explained in the following cathodic and anodic half-cell reactions:



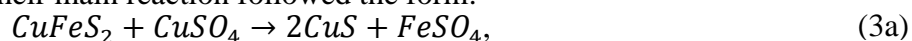
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57 The collection of crystallites that make up a chalcopyrite particle will have a range of rest potentials due
58 to variabilities in point defect concentration, lattice dislocations, and crystallite distribution. These
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variabilities will affect local reaction rates, e.g., doping-induced photocatalytic activity of InVO_4 , [11] grain growth retardation due to dislocations in electrodeposited Cu, [12] and combustion kinetics of nanocomposite energetics [13]. Nevertheless, particle corrosion rates (i.e., Eqs. 1 & 2) will be highest when the cathodic/anodic electron flow is balanced at the interfaces between reacting crystallites. Thus, if the system starts at a moderate redox potential (i.e., 650 mV, standard hydrogen electrode, SHE), then the collective rest potential would be expected to gradually rise over time due to the preferential dissolution of those crystallites that are most thermodynamically and kinetically reactive. This effect would necessitate increasing the redox potential later in the leaching process to continue driving particle dissolution to completion.

Furthermore, the Pourbaix diagram for the Cu–Fe–S–O–H₂O system (Fig. 1) suggests that the dissolution pathway for recovery of Cu^{2+} from chalcopyrite in an acid medium is a complex process, with a variety of stable intermediate sulfides as potential reaction side products (e.g., Cu_5FeS_4 , CuS , Cu_2S). Fig. 1 also implies that low pH (<4) and a redox potential higher than 400 mV (SHE) is required to dissolve copper from chalcopyrite [10, 14, 15].

A large amount of research has been performed over the past several decades with a goal to better understand the thermodynamics and electrochemistry of the reactions involved in copper sulfide leaching. From this body of work, a number of processing approaches have been developed; these include, most notably, the use of heterogeneous leach catalysts [16–19] and chemical pre-conversion of chalcopyrite to more readily leachable copper sulfide products [20–25]. Especially relevant to the understanding of chalcopyrite leaching have been studies on the surface chemistry of chalcopyrite through surface spectroscopies (e.g., x-ray photoelectron, secondary ion mass, and x-ray absorption spectroscopies) and modeling (e.g., density functional theory). For example, modeling has been able to describe favorable/low-energy surfaces of chalcopyrite [26], the predicted oxidation states [27], and insights into the role of metal deficiency on surface passivation [28].

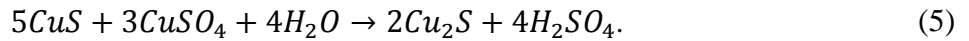
One of the more unique approaches to improving the leach kinetics involved the mechanochemical activation of chalcopyrite (CuFeS_2) particles in the Sherritt-Cominco process [9]. Their method focused on particle size reduction to achieve a P_{80} below 15 μm for the purpose of shortening the diffusion pathway through the particle. Their main reaction followed the form:



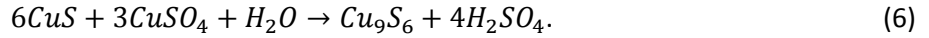
which was performed at temperatures $>150^\circ\text{C}$. Another reaction occurred for the bornite present in the concentrate, which was more desirable as a high-copper mineral:



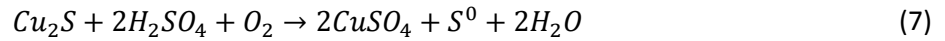
However, this process also suffered from an undesirable reaction that increased the amount of copper sulfate needed for the recycle by 20-30%:



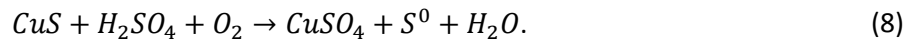
Furthermore, at the elevated temperatures they experience more copper sulfate consumption with the covellite (CuS) product through Eqs. (3) and (4):



To prevent this from happening, Swinkels and Berezowsky introduce dissolved oxygen into the acidic solution to convert the sulfides into elemental sulfur through the following reactions:



and



An oxygen partial pressure of 1.4 kg/cm² was found to be adequate for Fe³⁺ oxidation, but a range of 3.5–7.0 kg/cm² was preferred. As can be seen, this process was very energy intensive, since it required very high temperatures (above the boiling point of water) and a large supply of oxygen to prevent parasitic side reactions. FLSmith has developed a novel two-step approach for the atmospheric leaching of copper sulfides which uses (1) a pretreatment step utilizing chemical activation and (2) a downstream mechanochemical leaching step, which together alter lattice strain and thereby increase chemical reactivity [29, 30]. This method, drawing inspiration from other mechanochemical leaching activities [31–33], introduces additional copper (e.g., a few mol%) into the chalcopyrite crystal lattice to form non-stoichiometric Cu_xS_y compounds and is accomplished by drastically limiting the extent of reaction during the copper metathesis of chalcopyrite to covellite (CuS):



Through the use of chemical activation described above and the combination of grinding and leaching during the subsequent mechanochemical ROL process, the mechanism for dissolution becomes less influenced by electrochemical effects, and corrosion becomes seemingly insensitive to the surface passivation conditions [29]. In continuous pilot testing, copper doping of less than 0.5 mol% has significantly increased leach kinetics and copper recoveries [30, 34]. The lattice doping due to the chemical preconditioning/activation process will be the focus of the present study.

Materials and methods

Chalcopyrite was doped with 4 mol% copper as follows. A museum-grade chalcopyrite (CuFeS₂, Excalibur Minerals, USA) sample was ground to minus 635 mesh (less than 20 μm in diameter) using a ring and puck mill (BICO, USA). A stirred beaker was filled with deionized water (200 mL), adjusted between pH 1.0 and 4.0 with sulfuric acid, and heated to 80 °C. Copper sulfate pentahydrate (CuSO₄·5H₂O, 4.08 g, Alfa, USA) and ferrous sulfate heptahydrate (FeSO₄·7H₂O, 1.99 g, Alfa, USA) were added and the solution pH maintained between 2.0 and 4.0. Finely ground chalcopyrite (75.0 g)

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5 was added to the solution to initiate the conversion reaction. The redox potential and pH were recorded
6 throughout the process. Samples were taken during the course of the reaction, which proceeded for an
7 hour.
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10 Powder X-ray diffraction (XRD) measurements on planetary ball-milled (Pulverisette 6, 100 min
11 with polished agate media) chalcopyrite particles, using a Huber G670 with 10 min exposure, were
12 used to compare between non-activated and activated samples. The purity of the museum-grade
13 chalcopyrite was consequently verified with XRD.
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17 Transmission electron microscopy (TEM) samples were prepared with gallium-focused ion beam milling
18 in a Helios NanoLab DualBeam 600 with a scanning electron microscope (SEM, see Fig. 2a-c).
19 Platinum was deposited onto a chalcopyrite particle (stoichiometric ratio confirmed with X-ray energy
20 dispersive spectrometry) for transfer purposes. It was milled initially at 30 kV for bulk removal
21 around the slice before it was transferred next to a TEM grid and attached with additional platinum
22 deposition. The final thinning involved fine milling to sub-100 nm thickness at 5 kV in order to reduce
23 beam damage.
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27 TEM characterization was performed with a Tecnai T20 G2 operating at 200 kV accelerating voltage.
28 Beam alignments and astigmatism corrections were performed, and the TEM was calibrated using the
29 ring diffraction pattern of the platinum deposited during ion milling. The pattern was found to match
30 that of XRD reference values for platinum (see Online Resource 1).
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33 34 **Results and discussion**

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36 A previous study on activated chalcopyrite by Chaiko, et al. [30], found that low-conversion
37 metathesis reactions do indeed alter the crystal lattice well beyond the local reaction site. This
38 interesting phenomenon is the primary focus of the current investigation. Diffraction data were
39 initially gathered using XRD (Fig. 3) to see whether it is possible to detect any differences resulting
40 from the chemical activation (i.e., presence of new peaks). However, a maximum of 4 mol%
41 conversion was too low to show a measurable effect on the bulk lattice properties. To better probe
42 changes in lattice properties, more precise analytical techniques such as TEM were employed.
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46 TEM images of some areas of interest were taken in bright field mode, wherein select area
47 electron diffraction (SAED) was performed in distinctive regions. This can be seen best in Fig. 4,
48 where two types of regions in the activated samples are apparent. The main features to note are regions
49 that appear to be either polycrystalline (as in the upper part of Fig. 4a) or close to single crystalline (as
50 in the lower two parts of Fig. 4a, labeled crystals A and B), since some twinning is commonly
51 observed in natural chalcopyrite [35]. Indeed, these two regions showed significant differences when
52 their diffraction patterns were compared.
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56 Although the possibility of a difference between crystals A and B of the sample in Fig. 4 was considered,
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58 the d-spacings calculated from their diffraction patterns proved that these were instead different
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crystallographic orientations of the chalcopyrite lattice. These patterns were analyzed according to two different methods that produced nearly identical results. The first method involved transforming the diffraction spots into a radial distribution profile (see Fig. 5). Peak fitting was then utilized to determine the major peaks of each profile (Table 1). Based on the analysis, it was possible to determine that there was peak overlap between the two chalcopyrite regions (e.g., crystals A and B in Fig. 4); however, their intensities were of different strengths as a result of diffraction along separate zone axes.

An important discovery made evident from diffraction pattern analysis is that the d-spacings from the activated and non-activated regions are heavily altered. This effect was anticipated since the activated regions are partially converted to a complex copper sulfide, as evidenced from previous work by Chaiko, et al. [30], as well as verification of reaction kinetics of the activation step via chemical Eq. 3 (see Online Resource 2). However, it was surprising to find that the regions which are seemingly non-activated also show very different d-spacings relative to that of chalcopyrite. In that study, the d-spacings prior to activation were in agreement with reference data obtained during the XRD analysis.

The other method of analysis utilized the software CrystTBox [36, 37] to fit the collected diffraction patterns with reference data. A few examples of the fitting performed can be seen in Figs. 6, 7, and 8 and Tables 2 and 3.

In the case of chalcopyrite crystals A and B, which had only a few crystallites displaying diffraction spots, it was easy to perform the fitting using the diffraction fitting toolkit (see Fig. 6). Because the reaction product during activation was anticipated to be covellite-like in structure (Eq. 9), covellite reference data were employed. However, using the covellite reference pattern as a model produced a poor fit and led to lattice vectors in forbidden planes. Although there was more than one crystal to fit, it was possible to focus on one set of crystal diffraction spots. By assigning each spot to a lattice plane (Fig. 6b), the fitting determined the zone axis of crystal A as $[0 -2 1]$. Similarly, the zone axis of crystal B was determined to be $[1 -1 0]$, which supports our earlier conclusion that the radial intensity peak differences were due to different crystal orientations. The validity of the lattice plane identification can be drawn from the associated Fig. 7. Indeed, the diffraction spot intensities for the fitting of lattice vectors A, B, and D (from Table 2) to their identified planes also carry a similar ratio of spot sizes for both the pattern and simulation.

In the case of the polycrystalline and presumably activated region, where the electron diffraction pattern shows a larger degree of poly-crystallinity, a ring fitting procedure (Fig. 8 and Table 3) typically used for amorphous materials was attempted. In this region, chalcopyrite reference data did not match the SAED pattern, so a fit with covellite was attempted instead. Although there are questions as to the reliability of the Miller indices of Fig. 7, since these are forbidden planes in the crystal lattice, the diffraction data did match a number of d-spacings associated with covellite better than it did the chalcopyrite reference pattern. This shows that the activated region is altered to be covellite-like, and this

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5 lattice alteration can be clearly identified using diffraction imaging with TEM, where powder XRD is
6 insufficiently sensitive to the few mol% conversion.
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9 It should be once again noted that the d-spacings calculated with the radial distribution profile and lattice
10 fitting uncovered similar deviations from reference data. Although the fitting was capable of identifying
11 lattice planes and the zone axis, the values for the d-spacings show that there is significant lattice strain
12 induced throughout the particle by lattice doping. Of great interest are the large d-spacing values which
13 are observed in the crystalline chalcopyrite regions and are consistently greater than the expected value
14 (3.04 Å for the [1 1 2] d-spacing, 1.85 Å for [0 2 4], and 2.65 Å for [2 0 0]). It should be noted that ion-
15 milling has an effect of increasing the lattice spacing at the [1 1 2] plane even in pure chalcopyrite, but
16 no such effect on other planes (see Online Resource 3). A possible conclusion is that atoms in the lattice
17 are sitting at larger distances from each other, leading to a lower atom density. Despite having been
18 milled to a thickness of less than 100 nm, the chalcopyrite particles observed are strained, suggesting that
19 the native doped particles may be under even further strain.
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25 Such effects may be an important contributing factor that play key roles in promoting the improved
26 kinetics of the activated particles within the mechanochemical leaching system. Lattice deformations
27 in solids have been clearly shown to affect chemical kinetics and transport phenomena [38, 39],
28 and natural chalcopyrite has been observed to accommodate its structure to other lattices [35]. One
29 would expect that the induced lattice strain might reduce the activation energy required for copper
30 dissolution, and, secondly, that the particles may be more easily broken up during mechanical action in
31 the Stirred Media Reactor (SMRt). Although the effects of the activation reaction on electrochemical
32 properties have yet to be determined, the disruption in the lattice provides important insight into one of
33 the main mechanisms for improved copper leaching in the ROL process. Supplementation with
34 modeling would help to better elucidate the lattice activation mechanism.
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40 **Conclusions**

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42 In this study, it was found that the chemical activation (i.e., lattice doping with only a few mol
43 % conversion) of chalcopyrite particles has a significant effect on the crystal structure. In the regions
44 where the activation reaction was clearly evidenced through TEM as a polycrystalline phase, the
45 diffraction patterns revealed a lattice that more closely resembled covellite than chalcopyrite,
46 indicating an intermediate phase between the two. Regions of the particle, though characterized
47 with only a few crystallites, had diffractions that resembled chalcopyrite lattice planes, but showed
48 altered d-spacings (either equal to or larger than expected), indicating that the extent of activation
49 reaches beyond the reacted regions.
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54 It is likely that the lattice of chalcopyrite has been stressed by the heavy doping process (e.g., about 4
55 mol% conversion) to the point that particles readily relieve lattice strain by breaking apart during ion
56 milling. After the stress has been released, the lattice partially relaxes to a more energetically favorable
57 structure but still retains larger-than-expected d-spacings, which are not visible by XRD. Rather than
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relaxing to the expected lattice parameters of unmodified chalcopyrite, these activated particles remain in this new mixed covellite-chalcopyrite state, which remains stable over at least several months. This could, at least partly, explain the improved leaching kinetics during the mechanochemical ROL process.

Additionally, the possibility that altered electrochemical properties influence leach kinetics still needs to be addressed. In particular, we aim to explain how the structural changes, arising from the activated chalcopyrite crystallites, reflect on the flow of electrons and corresponding changes in the redox potential during leaching. Future efforts will focus on characterization of the electronic structure of these activated particles. However, the implications point toward an activation process that can make significant changes to the properties of the host material through a relatively simple modification procedure and only a small amount of doping via a solution-based method. In the future, we hope to elucidate further the effects of activation through surface spectroscopy studies and computational modeling.

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Conflicts of interest

The authors declare that all relationships and interests of those involved in the manuscript do not have any conflicts which could potentially influence or bias the submitted work.

Electronic supplementary information

Below is the link to the electronic supplementary material. Online resource 1 includes a report of the ring diffraction analysis used to confirm the correct calibration of the TEM. Online resource 2 provides information on the kinetics of the activation reaction analyzed from inductively coupled plasma mass spectrometry (ICP-MS). Online resource 3 serves as a control for the TEM diffraction analysis since it provides details on pure chalcopyrite for comparison. (DOCX2460 kb)

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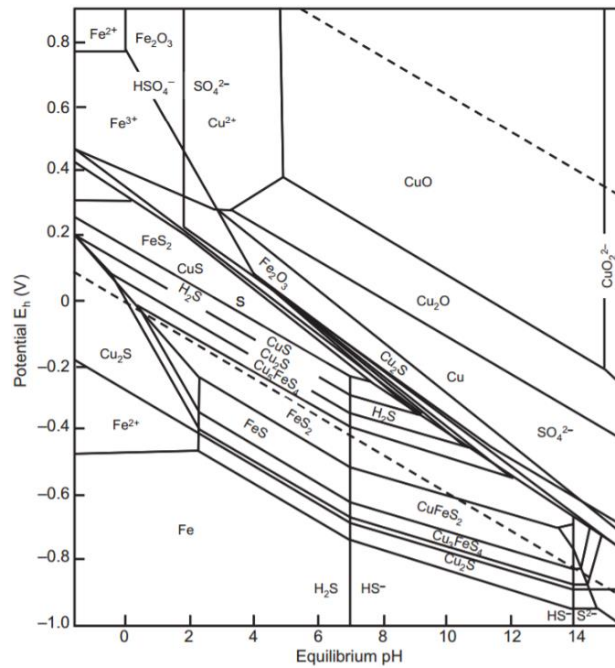


Figure 1 Pourbaix diagram for the Cu-Fe-S-O-H₂O system at 25°C. [Cu] = 0.01 M, [Fe] = [S] = 0.1 M. Reproduced with permission from Elsevier.[12]¹

¹ Reprinted from Extractive Metallurgy of Copper, 5th edition, Schlesinger ME, Biswas AK, Chapter 15 - Hydrometallurgical Copper Extraction: Introduction and Leaching, Pages 281-322, Copyright 2011, with permission from Elsevier.

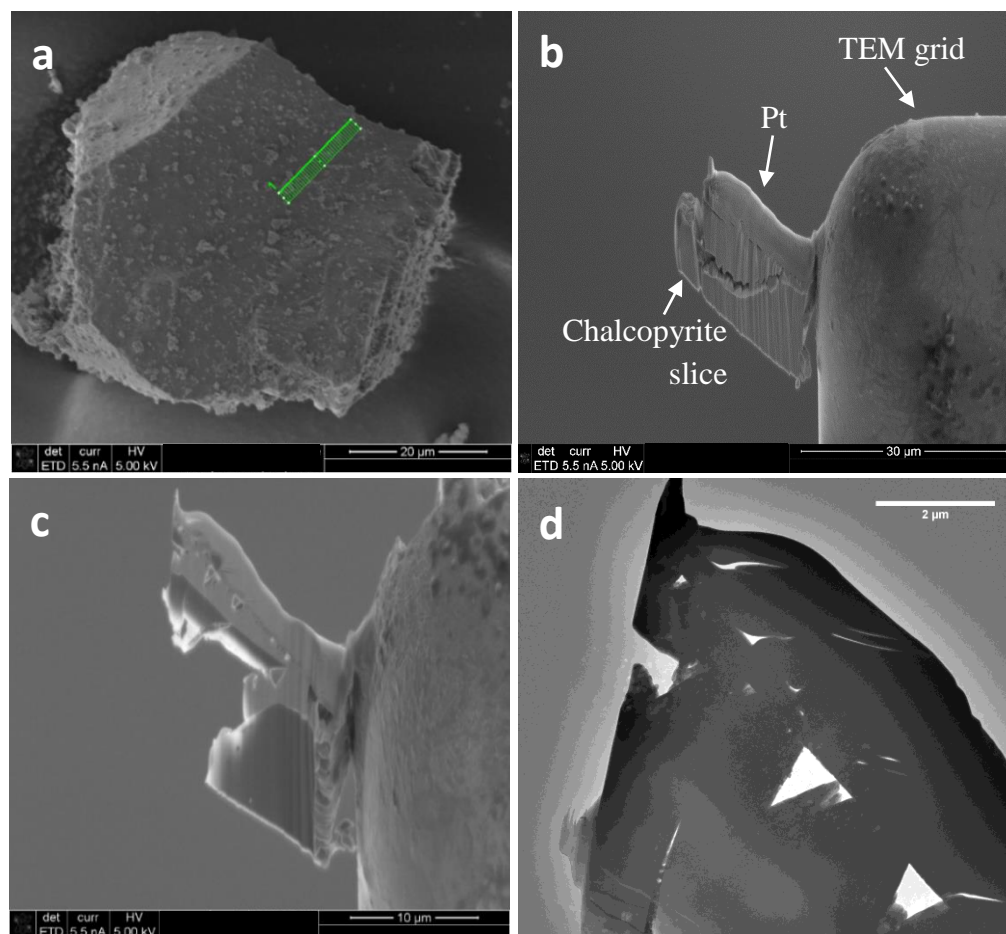


Figure 2 a SEM image of a chalcopyrite particle examined in this study with green rectangular area marked “1” where platinum was to be deposited. **b** The slice viewed in SEM from the side after course milling with the focused ion beam at 30 kV and attachment to a TEM grid on the right. The chalcopyrite portion of the sample is more easily distinguished visually with the presence of striations. The platinum deposited on top of the particle is labeled “Pt deposit.” **c** SEM image of the same slice after further thinning at 5 kV to less than 100 nm thickness. As can be seen, portions of the slice have broken off as it became thinner. **d** TEM image of the top portion of the same slice from Fig. 2c which was used for some of the diffraction studies.

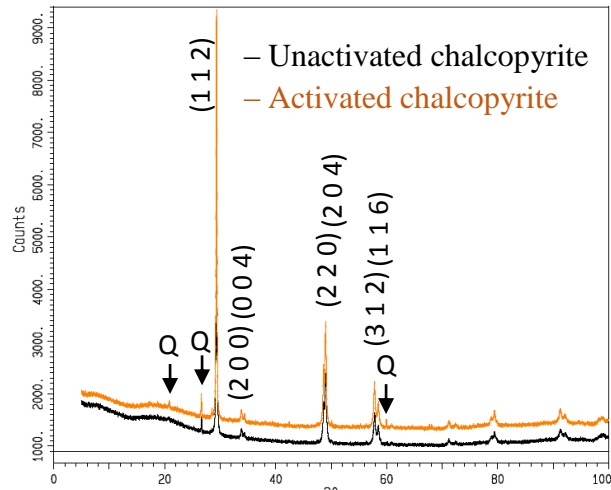


Figure 3 XRD patterns of the chalcopryrite powders with and without activation. The activated sample has a few additional minor peaks, which are due to quartz impurities (labeled Q). First seven major peaks of chalcopryrite are presented (AMCSD 0018622).

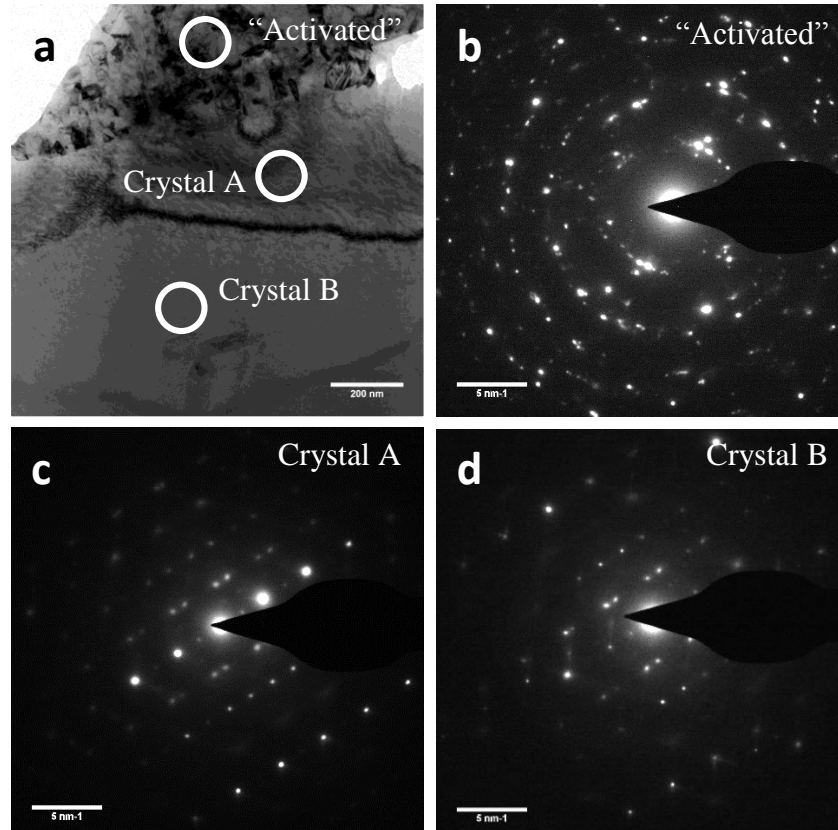


Figure 4 **a** TEM image of the area over which the following diffraction patterns were taken. Circles on the image indicate the corresponding diffraction patterns to follow. **b** SAED pattern which is referred by the upper circle in the previous image and within a polycrystalline, presumably activated region. **c** SAED pattern which is referred by the middle circle and corresponds to a possible chalcopyrite region (denoted “crystal A”). **d** SAED pattern corresponding to a bulk chalcopyrite region, which is referred by the lower circle (denoted “crystal B”). Twinning was observed in **c** and **d**.

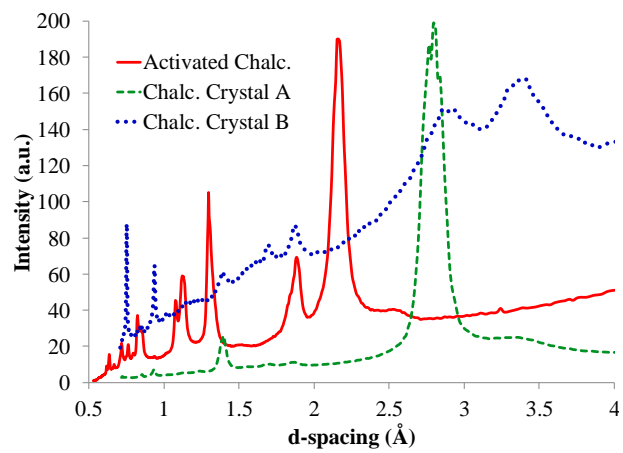


Figure 5 The radial distribution profile of the three SAED locations in Fig. 4.

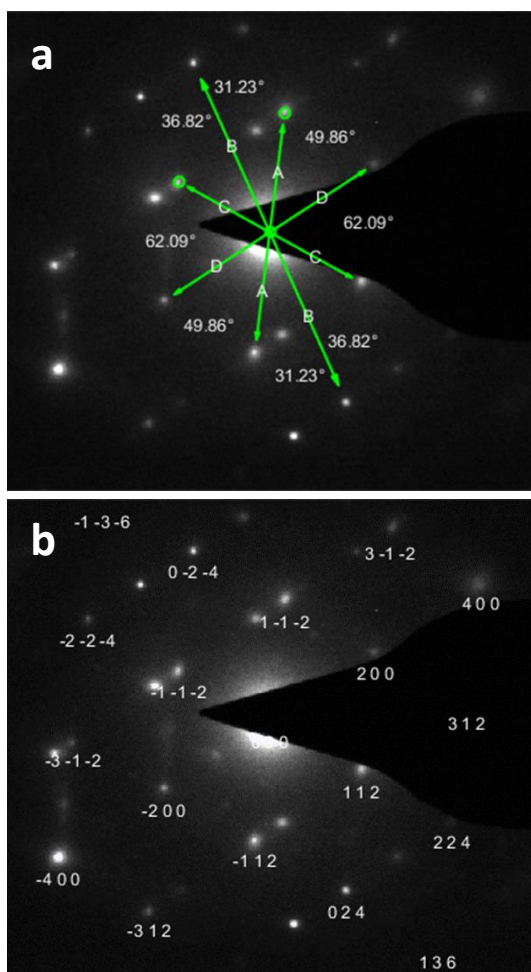


Figure 6 Fitting report with chalcopyrite reference data (AMCSD 0018623) for the chalcopyrite crystal A. **a** Lattice vector quantification after spot matching. **b** Zone axis was calculated to be $[0 -2 1]$ from vectors above.

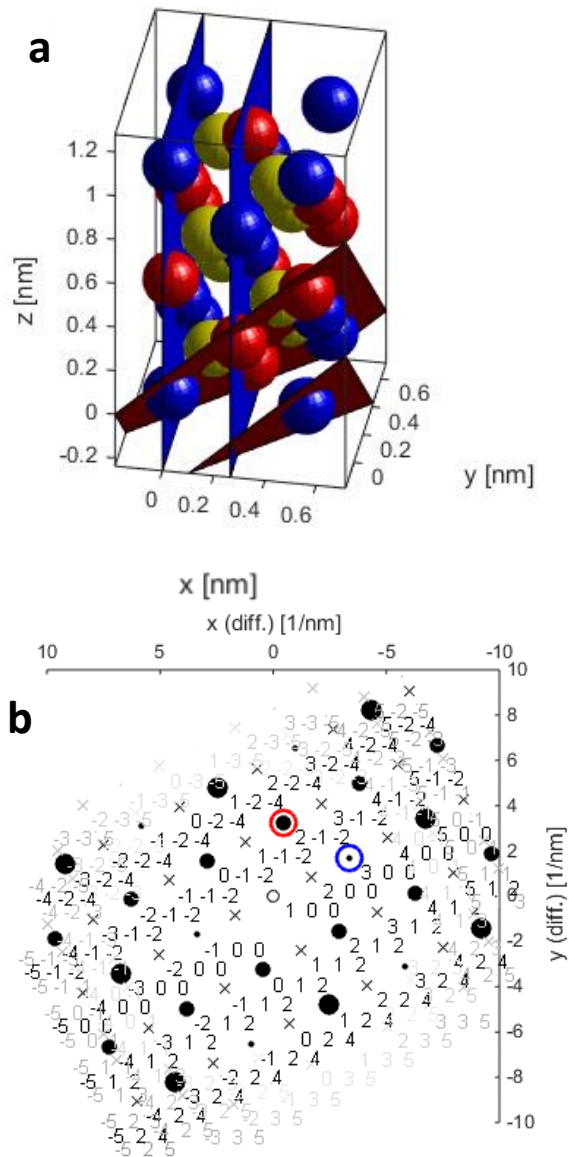


Figure 7 a Unit cell generated using chalcopyrite reference data (AMCSD 0018623) and the $[1\ -1\ -2]$ and $[2\ 0\ 0]$ lattice planes (blue on right and red on left, respectively). The atoms are as follows: iron in red, copper in blue, and sulfur in yellow. **b** The simulated diffraction pattern of **Fig. 6** SAED along the $[0\ -2\ 1]$ zone axis with highlighting of the two planes (same color coding for planes). Note the similar ratio of beam spot sizes with **Fig 6b**.

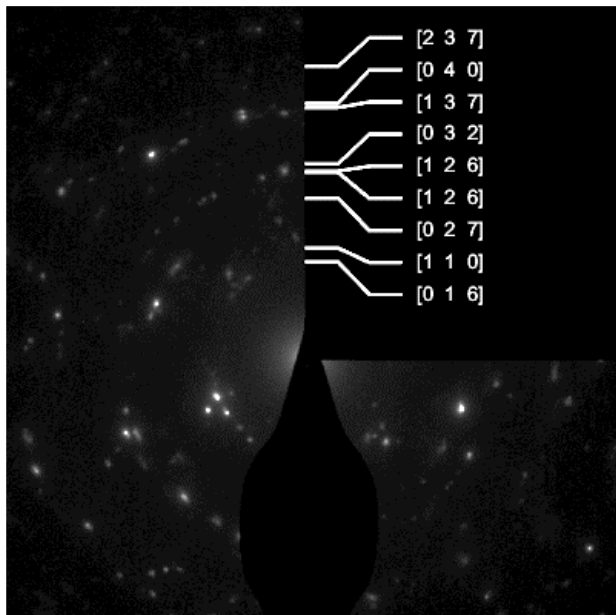


Figure 8 Ring pattern fitting against covellite reference data (AMCSD 0000534) for the polycrystalline activated region.

Table 1 Summary of averaged peaks (in units of Å) from Fig. 5. Reference X-ray diffraction peaks are shown where applicable (AMCSD 0018623 for chalcopyrite and 0000534 for covellite).

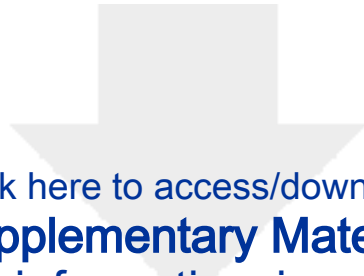
Non-activated	Activated	Ref. Data	Candidate
3.353			
	3.254	3.221	Cov.
	3.020	3.048	Cov.
2.852		2.813	Cov.
	2.559	2.605	Chalc.
2.164			
	2.011		
1.989			
	1.919	1.903	Cov.
1.871	1.876	1.868	Chalc.
	1.715	1.735	Cov.
1.693			
1.546		1.575	Chalc.
1.394	1.397	1.391	Cov.
	1.324	1.344	Cov.
1.254			
	1.201	1.212	Cov.
1.143			
	1.128		Cov.

Table 2 Summary of d-spacings and lattice planes from Fig. 6.

	d-spacing		Vector identification
	[Å]	[1/nm]	
A	2.9002	3.4481	1 -1 -2
B	1.8739	5.3364	0 -2 -4
C	3.3524	2.9829	-1 -1 -2
D	2.7633	3.6189	-2 0 0

Table 3 Summary report of associated **Fig. 7**.

Ring identification				
Plane	Radius [1/nm]		d-spacing [Å]	
	theor.	measured	theor.	measured
[2 3 7]	13.941	13.925	0.72	0.72
[0 4 0]	12.175	12.155	0.82	0.82
[1 3 7]	11.78	11.956	0.85	0.84
[0 3 2]	9.213	9.274	1.09	1.08
[1 2 6]	8.85	8.931	1.13	1.12
[1 2 6]	8.85	8.874	1.13	1.13
[0 2 7]	7.443	7.647	1.34	1.31
[1 1 0]	5.272	5.279	1.90	1.89
[0 1 6]	4.769	4.622	2.10	2.16



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